

A T 2 5 5 1 2 x - T H - T

Product Family

25 = Standard SPI
Serial EEPROM

Device Density

512 = 512 kilobit

Product Variation

x = Applies to select packages only.
See ordering code table for
variation details.

Shipping Carrier Option

B = Bulk (Tubes)

T = Tape and Reel, Standard Quantity Option

**Package Device Grade or
Wafer/Die Thickness**

H = Industrial Temperature Range
(-40°C to +85°C)

11 = 11mil Wafer Thickness

Package Option

S = SOIC

T = TSSOP

W = Wafer Unsawn